

# INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)

Docket Number (Optional)  
BUR920030025US1

Application Number  
10/605,440

Applicant(s)  
Robert Geffken et al.

Filing Date  
09/30/2003

Group Art Unit  
Unknown 2818

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

## FOREIGN PATENT DOCUMENTS

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

dlu		V. Arnal, J. Torres, P. Gayet, R. Gonella, P. Spinelli, M. Guillermet, J-P Reynard, GC. Verove; "Integration of a 3 Level CuSiO2 Air Gap Interconnect for Sub 0.1 micron DMOS Technologies;" IEEE, 6/01, pages 298-300.

EXAMINER  
Kew

DATE CONSIDERED  
04/26/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

## Title of Invention

ADJUSTABLE SELF-ALIGNED AIR GAP DIELECTRIC FOR  
LOW CAPACITANCE WIRING

Application Number :

10/605,440

Confirmation Number:

First Named Applicant:

Robert Geffken

Attorney Docket Number:

BUR920030025US1

Art Unit:

2818

Examiner:

D. NGUYEN

Search string:

( 5324683 or 6150232 or 6200900 or 6281585 or 6329279 or 6423629 or 6472266  
or 20020127844 or 20010023123 ).pn

## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
Ahn	1	5324683	1994-06-28	Fitch et al.		437	65
	2	6150232	2000-11-21	Chan et al.		438	421
	3	6200900	2001-03-13	Kitch		438	695
	4	6281585	2001-08-28	Bothra		257	758
	5	6329279	2001-12-11	Lee		438	619
	6	6423629	2002-07-23	Ahn et al.		438	622
Ahn	7	6472266	2002-10-29	Yu et al.		438	241

## US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
Ahn	1	20020127844	2002-09-12	Grill et al.		438	622
Ahn	2	20010023123	2001-09-20	Kim		438	587

## Signature

Examiner Name

Date

*[Signature]*

04/26/05